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- Max  $r_{DS(on)}$  = 53m $\Omega$  at V<sub>GS</sub> = -2.5V, I<sub>D</sub> = -5.5A
- Low profile 0.8mm maximum in the new package MicroFET 2X2 mm
- HBM ESD protection level > 3kV typical (Note 3)
- Free from halogenated compounds and antimony oxides
- RoHS Compliant

FAIRCHILD

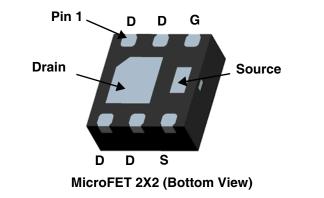


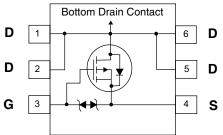
# **General Description**

This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-state resistance.

June 2014

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.





## MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage		-20	V	
V <sub>GS</sub>	Gate to Source Voltage		±12	V	
I <sub>D</sub>	Drain Current -Continuous	(Note 1a)	-7.3	_	
	-Pulsed		-24	— A	
P <sub>D</sub>	Power Dissipation	(Note 1a)	2.4	10/	
	Power Dissipation	(Note 1b)	0.9	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C	

### **Thermal Characteristics**

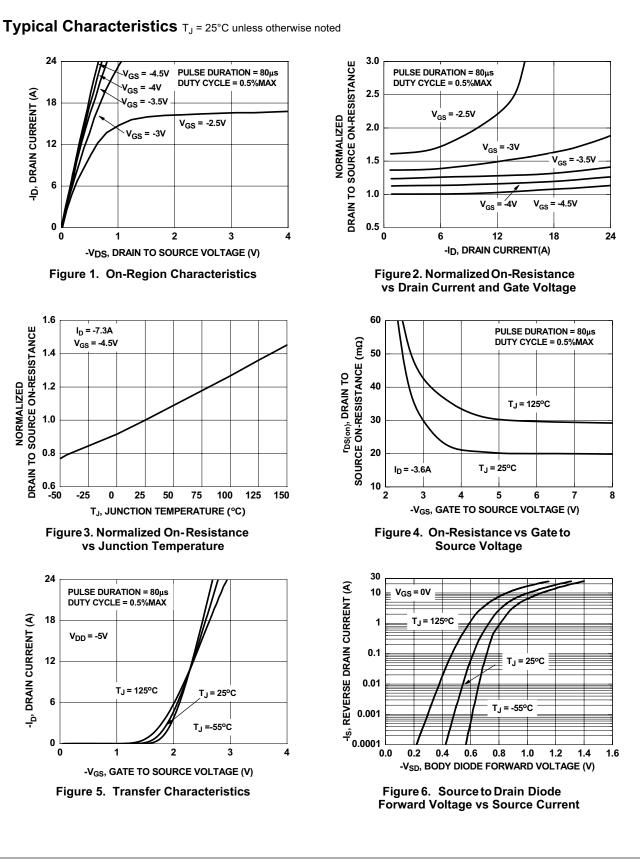
ſ	R <sub>θJA</sub>	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
	$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	145	0/00

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
520	FDMA520PZ	MicroFET 2X2	7"	8mm	3000 units

	Test Conditions	Min	Тур	Max	Units
cteristics			,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
Drain to Source Breakdown Voltage	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V	-20			V
Breakdown Voltage Temperature	$I_D = -250 \mu A$ , referenced to 25°C		-8.4		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{CS} = 0V$			-1	μA
Gate to Source Leakage Current				±10	μΑ
ctaristics					
		0.6	1 1	1 5	V
-	$v_{GS} - v_{DS}, I_D250\mu A$	-0.6	-1.1	-1.5	v
Temperature Coefficient	$I_D = -250 \mu A$ , referenced to 25°C		3.5		mV/°C
			-		mΩ
Static Drain to Source On Resistance					
				55	
Forward Iransconductance	$V_{DS} = -5V, I_D = -7.3A$		22		S
Characteristics					
Input Capacitance			1235	1645	pF
Output Capacitance			255	340	pF
Reverse Transfer Capacitance			225	340	pF
Characteristics					
Turn-On Delay Time			10	20	ns
Rise Time			29	47	ns
Turn-Off Delay Time	$-V_{GS} = -4.5V, R_{GEN} = 6\Omega$		83	133	ns
			74	119	ns
Fall Time					
Fall Time   Total Gate Charge			14	20	nC
	$V_{DD} = -5V, I_D = -7.3A$		14 2.9	-	nC nC
Total Gate Charge	- V <sub>DD</sub> = -5V, I <sub>D</sub> = -7.3A - V <sub>GS</sub> = -4.5V			-	_
Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge			2.9	-	nC
Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Irce Diode Characteristics	$V_{GS} = -4.5V$		2.9	20	nC nC
Total Gate Charge       Gate to Source Gate Charge       Gate to Drain "Miller" Charge       Irce Diode Characteristics       Maximum Continuous Drain-Source Diode	$V_{GS} = -4.5V$		2.9 4.4	20 	nC nC
Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge Irce Diode Characteristics	$V_{GS} = -4.5V$		2.9	20	nC nC
	Zero Gate Voltage Drain Current Gate to Source Leakage Current Cteristics Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics Turn-On Delay Time	CoefficientVZero Gate Voltage Drain Current $V_{DS} = -16V, V_{GS} = 0V$ Gate to Source Leakage Current $V_{GS} = \pm 12V, V_{DS} = 0V$ <b>cteristics</b> Gate to Source Threshold Voltage Temperature Coefficient $V_{GS} = V_{DS}, I_D = -250\mu A$ Static Drain to Source On Resistance $V_{GS} = -4.5V, I_D = -7.3A$ VGS = -4.5V, I_D = -7.3A, V_{GS} = -2.5V, I_D = -7.3A, V_{GS} = -4.5V, I_D = -7.3A, V_{GS} = -4.5V, I_D = -7.3A, V_{DS} = -4.5V, I_D = -7.3ACharacteristicsInput Capacitance $V_{DS} = -5V, I_D = -7.3A$ Output Capacitance $V_{DS} = -10V, V_{GS} = 0V, f = 1MHz$ Reverse Transfer Capacitance $V_{DD} = -10V, I_D = -7.3A$ Turn-On Delay Time Rise Time $V_{DD} = -10V, I_D = -7.3A$	CoefficientVZero Gate Voltage Drain Current $V_{DS} = -16V, V_{GS} = 0V$ Gate to Source Leakage Current $V_{GS} = \pm 12V, V_{DS} = 0V$ cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = -250\muA$ Gate to Source Threshold Voltage $I_D = -250\muA$ , referenced to $25^{\circ}C$ Gate to Source Threshold Voltage $V_{GS} = -4.5V, I_D = -7.3A$ Static Drain to Source On Resistance $V_{GS} = -4.5V, I_D = -7.3A$ VGS = -4.5V, $I_D = -7.3A$ $V_{GS} = -4.5V, I_D = -7.3A$ VGS = -4.5V, $I_D = -7.3A$ $V_{DS} = -5V, I_D = -7.3A$ Characteristics $V_{DS} = -5V, I_D = -7.3A$ Input Capacitance $V_{DS} = -10V, V_{GS} = 0V, f = 1MHz$ Characteristics $I_D = -10V, V_{GS} = 0V, f = 1MHz$ Turn-On Delay Time $V_{DD} = -10V, I_D = -7.3A$	ColemicationImage: ColemicationZero Gate Voltage Drain Current $V_{DS} = -16V, V_{GS} = 0V$ Gate to Source Leakage Current $V_{GS} = \pm 12V, V_{DS} = 0V$ CteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = -250\mu A$ $-0.6$ Gate to Source Threshold Voltage $I_D = -250\mu A$ , referenced to $25^{\circ}C$ $3.5$ Temperature Coefficient $I_D = -250\mu A$ , referenced to $25^{\circ}C$ $3.5$ Static Drain to Source On Resistance $V_{GS} = -4.5V, I_D = -7.3A$ $26$ $V_{GS} = -4.5V, I_D = -7.3A$ $26$ $V_{GS} = -4.5V, I_D = -7.3A$ $22$ Characteristics $V_{DS} = -5V, I_D = -7.3A$ $22$ Characteristics $V_{DS} = -5V, I_D = -7.3A$ $22$ Characteristics $V_{DS} = -10V, V_{GS} = 0V, f = 10Hz$ $225$ Characteristics $V_{DD} = -10V, I_D = -7.3A$ $225$	ColenicientVIIZero Gate Voltage Drain Current $V_{DS} = -16V, V_{GS} = 0V$ -1Gate to Source Leakage Current $V_{GS} = \pm 12V, V_{DS} = 0V$ $\pm 10$ cteristicsGate to Source Threshold Voltage $V_{GS} = V_{DS}, I_D = -250\mu A$ $-0.6$ $-1.1$ $-1.5$ Gate to Source Threshold Voltage $I_D = -250\mu A$ , referenced to $25^{\circ}$ C $3.5$ $3.5$ Gate to Source Threshold Voltage $I_D = -250\mu A$ , referenced to $25^{\circ}$ C $3.5$ $3.5$ Static Drain to Source On Resistance $V_{GS} = -4.5V, I_D = -7.3A$ $26$ $30$ V_{GS} = -2.5V, I_D = -5.5A $442$ $53$ V_{GS} = -4.5V, I_D = -7.3A, T_J = 125^{\circ}C $36$ $55$ Forward Transconductance $V_{DS} = -5V, I_D = -7.3A$ $22$ CharacteristicsInput Capacitance $V_{DS} = -10V, V_{GS} = 0V, f = 10Hz$ $1235$ $1645$ Output Capacitance $f = 1MHz$ $225$ $340$ CharacteristicsTurn-On Delay Time $V_{DD} = -10V, I_D = -7.3A$ $29$ $47$

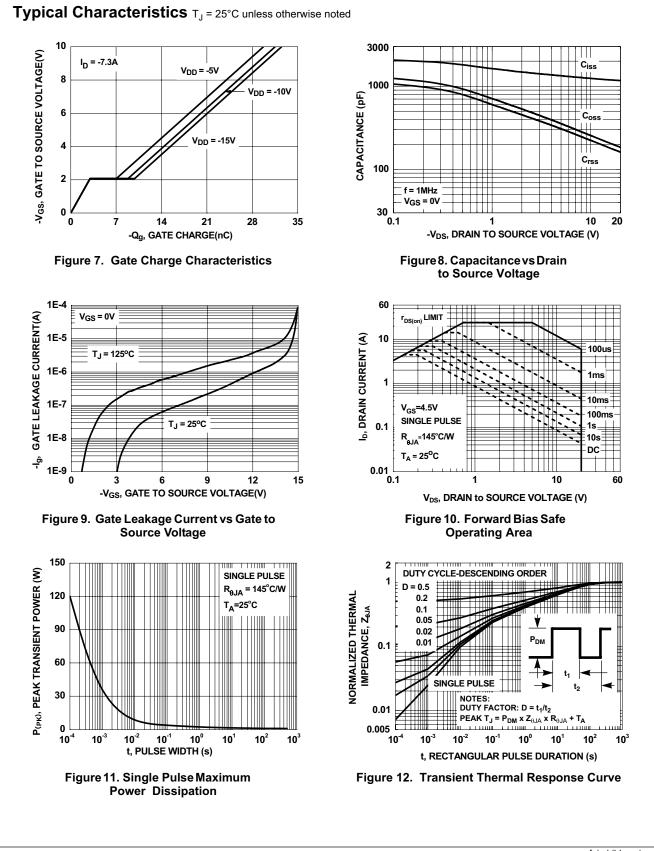
Pulse Test: Pulse Width < 300μs, Duty cycle < 2.0%.</li>
 The diode connected between the gate and the source serves only as protection against ESD. No gate overvoltage rating is implied.



FDMA520PZ Rev.B3

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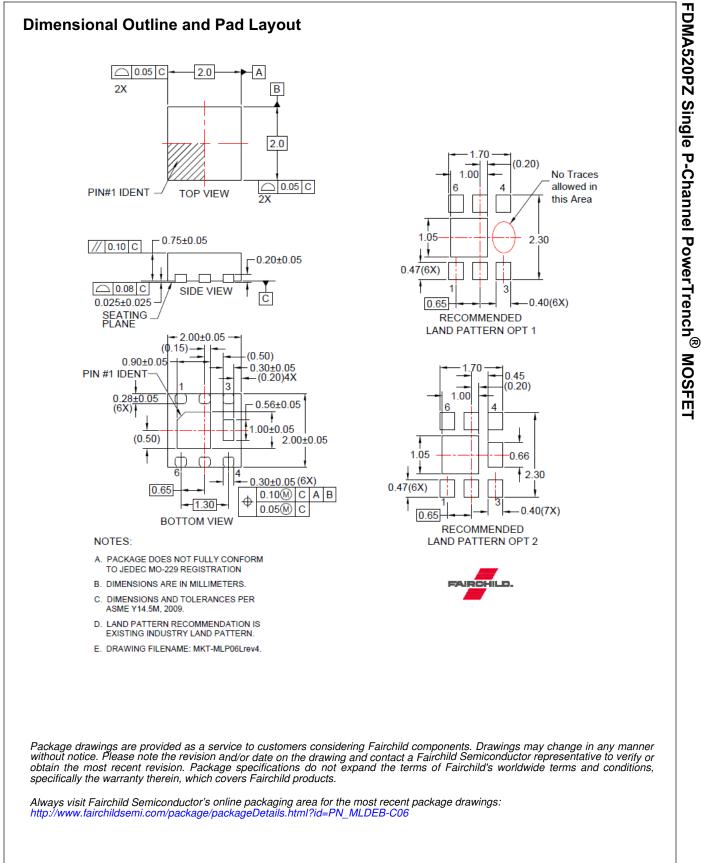


FDMA520PZ Rev.B3

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FDMA520PZ Single P-Channel PowerTrench<sup>®</sup> MOSFET



MOSFET



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